



Dimensions

Footprint	6032
L	6mm +/-0.3mm
W	3.2mm +/-0.3mm
H	2.5mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
K	1.8mm TYP

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	750

General Information

Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, Low ESR, Surge Robust
Features	Low ESR, Surge Robust, Automotive
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete.

Specifications

Capacitance	33 uF
Capacitance Tolerance	10%
Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
ESR	0.38 Ohms (100kHz)
Ripple Current	540 mAmps (25C), 486 mAmps (85C), 216 mAmps (125C)
Leakage Current	3.3 uA